

1.2V Drive Pch MOSFET

EM6J1

●Structure

Silicon P-channel MOSFET

●Features

- 1) Two Pch MOSFET are put in EMT6 package.
- 2) High-speed switching.
- 3) Ultra low voltage drive (1.2V drive).
- 4) Built-in G-S Protection Diode.

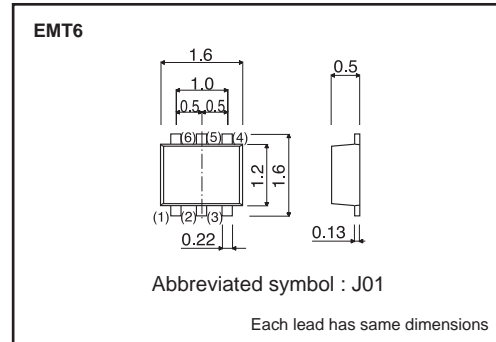
●Applications

Switching

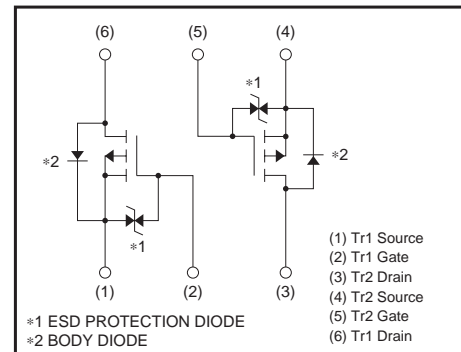
●Packaging specifications

| Type | Package | Taping |
|-------|------------------------------|--------|
| | Code | T2R |
| | Basic ordering unit (pieces) | 8000 |
| EM6J1 | | ○ |

●Dimensions (Unit : mm)



●Inner circuit



●Absolute maximum ratings (Ta=25°C)

<It is the same ratings for the Tr1 and Tr2.>

| Parameter | Symbol | Limits | Unit |
|------------------------------|------------|---------------|--------------|
| Drain-source voltage | V_{DSS} | -20 | V |
| Gate-source voltage | V_{GSS} | ±10 | V |
| Drain current | Continuous | ±200 | mA |
| | Pulsed | I_{DP}^{*1} | ±800 |
| Source current (Body Diode) | Continuous | -100 | mA |
| | Pulsed | I_{SP}^{*1} | -800 |
| Total power dissipation | P_D^{*2} | 150 | mW / TOTAL |
| | | 120 | mW / ELEMENT |
| Channel temperature | Tch | 150 | °C |
| Range of storage temperature | Tstg | -55 to +150 | °C |

*1 $P_w \leq 10\mu s$, Duty cycle $\leq 1\%$

*2 Each terminal mounted on a recommended land

●Thermal resistance

| Parameter | Symbol | Limits | Unit |
|--------------------|--------------|--------|------------------|
| Channel to ambient | Rth (ch-a) * | 833 | °C / W / TOTAL |
| | | 1042 | °C / W / ELEMENT |

* Each thermal mounted on a recommended land

●Electrical characteristics (Ta=25°C)

<It is the same ratings for the Tr1 and Tr2.>

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|---|----------------|------|------|----------|----------|------------------------------------|
| Gate-source leakage | I_{GSS} | – | – | ± 10 | μA | $V_{GS} = \pm 10V, V_{DS} = 0V$ |
| Drain-source breakdown voltage | $V_{(BR)DSS}$ | –20 | – | – | V | $I_D = -1mA, V_{GS} = 0V$ |
| Zero gate voltage drain current | I_{DSS} | – | – | –1 | μA | $V_{DS} = -20V, V_{GS} = 0V$ |
| Gate threshold voltage | $V_{GS(th)}$ | –0.3 | – | –1.0 | V | $V_{DS} = -10V, I_D = -100\mu A$ |
| Static drain-source on-state resistance | $R_{DS(on)}$ * | – | 0.8 | 1.2 | Ω | $I_D = -200mA, V_{GS} = -4.5V$ |
| | | – | 1.0 | 1.5 | Ω | $I_D = -100mA, V_{GS} = -2.5V$ |
| | | – | 1.3 | 2.2 | Ω | $I_D = -100mA, V_{GS} = -1.8V$ |
| | | – | 1.6 | 3.5 | Ω | $I_D = -40mA, V_{GS} = -1.5V$ |
| | | – | 2.4 | 9.6 | Ω | $I_D = -10mA, V_{GS} = -1.2V$ |
| Forward transfer admittance | $ Y_{fs} $ * | 0.2 | – | – | S | $V_{DS} = -10V, I_D = -200mA$ |
| Input capacitance | C_{iss} | – | 115 | – | pF | $V_{DS} = -10V$ |
| Output capacitance | C_{oss} | – | 10 | – | pF | $V_{GS} = 0V$ |
| Reverse transfer capacitance | C_{rss} | – | 6 | – | pF | $f = 1MHz$ |
| Turn-on delay time | $t_{d(on)}$ * | – | 6 | – | ns | $V_{DD} = -10V$ |
| Rise time | t_r * | – | 4 | – | ns | $I_D = -100mA$ $V_{GS} = -4.5V$ |
| Turn-off delay time | $t_{d(off)}$ * | – | 17 | – | ns | $R_L = 100\Omega$ |
| Fall time | t_f * | – | 17 | – | ns | $R_G = 10\Omega$ |
| Total gate charge | Q_g * | – | 1.4 | – | nC | $V_{DD} = -10V, I_D = -200mA$ |
| Gate-source charge | Q_{gs} * | – | 0.3 | – | nC | $V_{GS} = -4.5V$ |
| Gate-drain charge | Q_{gd} * | – | 0.3 | – | nC | $R_L = 50\Omega, R_G = 10\Omega$ |

*Pulsed

●Body diode characteristics (Source-drain)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|-----------------|------------|------|------|------|------|-----------------------------|
| Forward voltage | V_{SD} * | – | – | –1.2 | V | $I_S = -200mA, V_{GS} = 0V$ |

*Pulsed

●Electrical characteristics curves

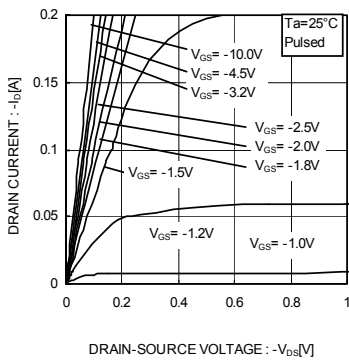


Fig.1 Typical output characteristics (I)

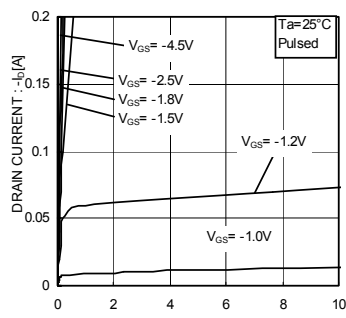


Fig.2 Typical output characteristics (II)

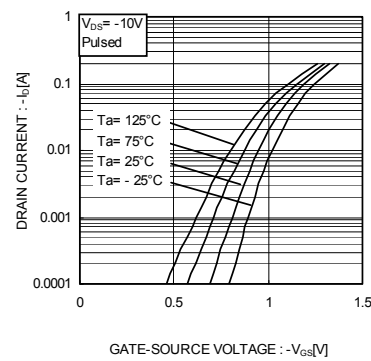


Fig.3 Typical Transfer Characteristics

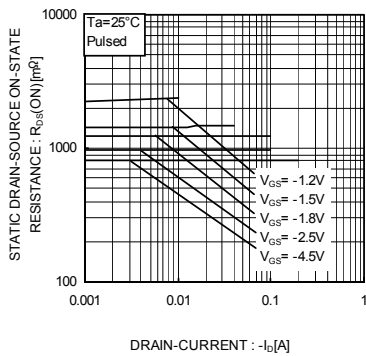


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (I)

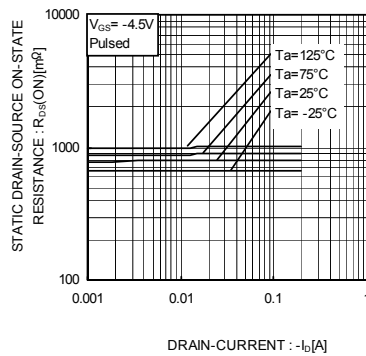


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current (II)

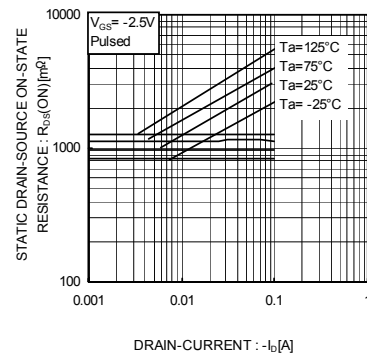


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current (III)

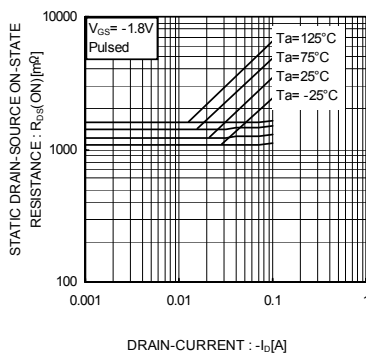


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (IV)

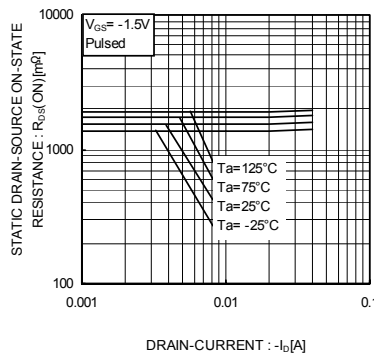


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (V)

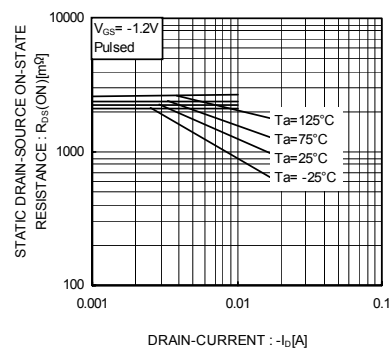


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (VI)

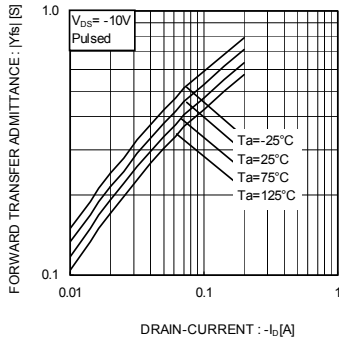


Fig. 10 Forward Transfer Admittance vs. Drain Current

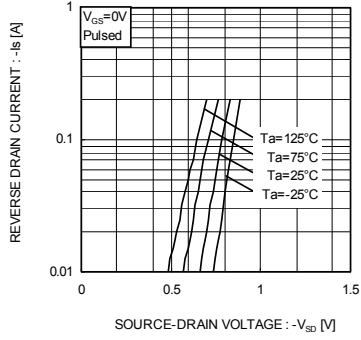


Fig. 11 Reverse Drain Current vs. Source-Drain Voltage

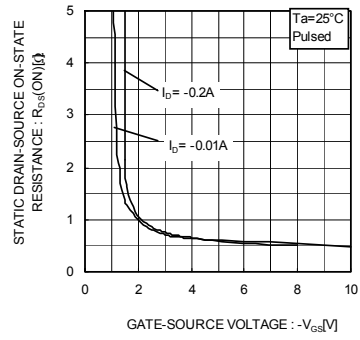


Fig. 12 Static Drain-Source On-State Resistance vs. Gate Source Voltage

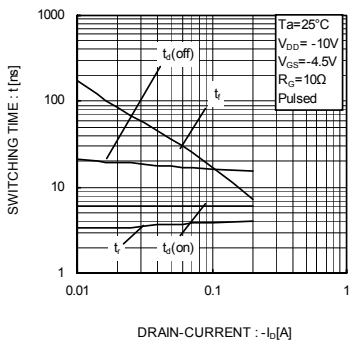


Fig. 13 Switching Characteristics

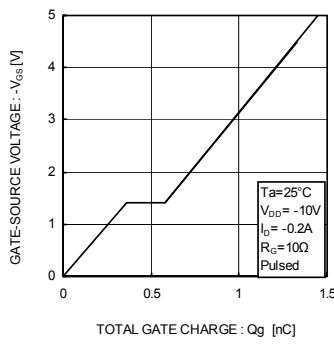


Fig. 14 Dynamic Input Characteristics

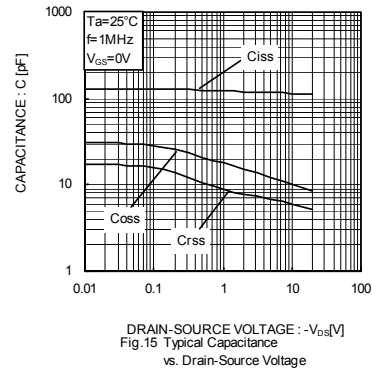


Fig. 15 Typical Capacitance vs. Drain-Source Voltage

●Measurement circuit

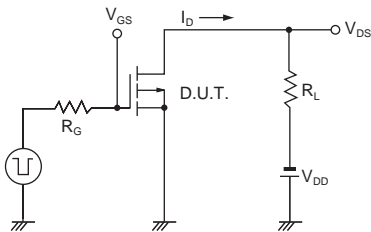


Fig. 1-1 Switching Time Measurement Circuit

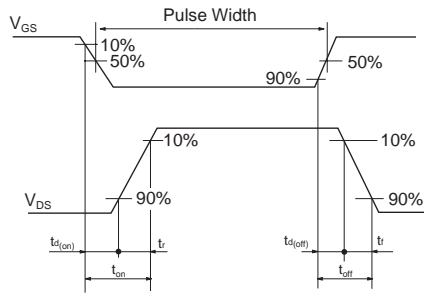


Fig. 1-2 Switching Waveforms

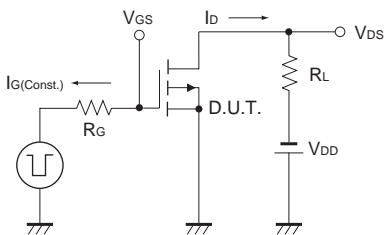


Fig. 2-1 Gate Charge Measurement Circuit

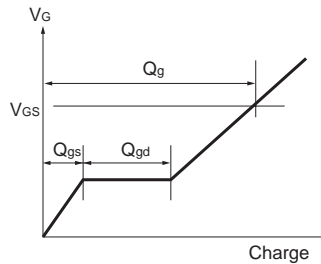


Fig. 2-2 Gate Charge Waveform

●Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

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